Data Sheet

Customer:

Part No: CL-SP192YG-5mA-02

Sample No:

Description: 1608 SMD YG Color

Item No:

Customer			
Check	Inspection	Approval	Date

Features

_1.6mmX0.8mm SMT LED, 0.60mm THICKNESS.

_LOW POWER CONSUMPTION.

_WIDE VIEWING ANGLE.

_IDEAL FOR BACKLIGHT AND INDICATOR.

_VARIOUS COLORS AND LENS TYPES AVAILABLE.

_PACKAGE: 4000PCS / REEL.

_RoHS COMPLIANT.

Description

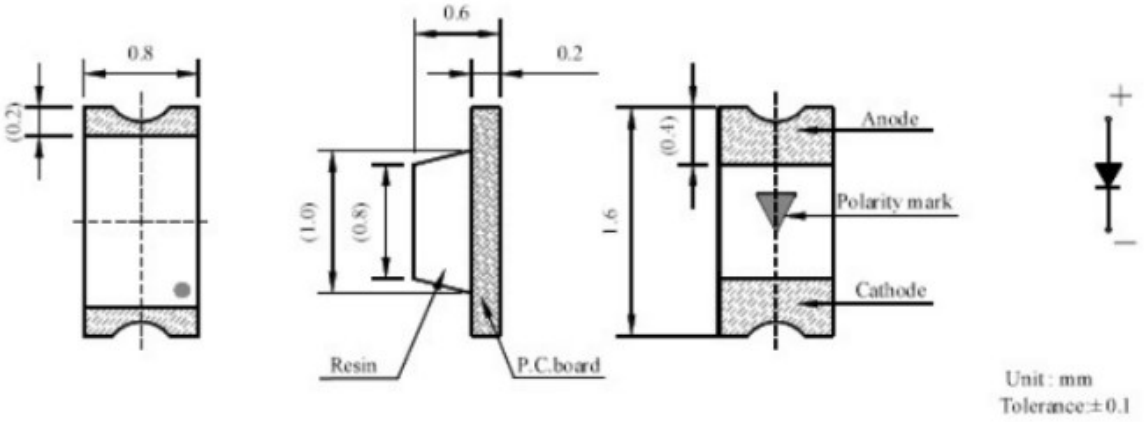
The Yellow source color devices are made with

Gallium

Arsenide Phosphide on Gallium Phosphide

Yellow Light

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is ±0.1(0.004") unless otherwise noted.

3.Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 5mA		Viewing Angle
			Min.	Typ.	2 θ 1/2
SP192YG-5mA-02	SUPER BRIGHT ORANGE (InGaAlP)	WATER CLEAR	1.2	5.7	120

Note:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Min	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Orange	568	574	nm	IF=5mA
λD	Dominant Wavelength	Super Bright Orange			nm	IF=5mA
Δλ1/2	Spectral Line Half-width	Super Bright Orange	29		nm	IF=5mA
C	Capacitance	Super Bright Orange	30		pF	VF=0V;f=1MHz
VF	Forward Voltage	Super Bright Orange	1.7	2.2	V	IF=5mA
IR	Reverse Curren	Super Bright Orange		2	uA	VR = 7V

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

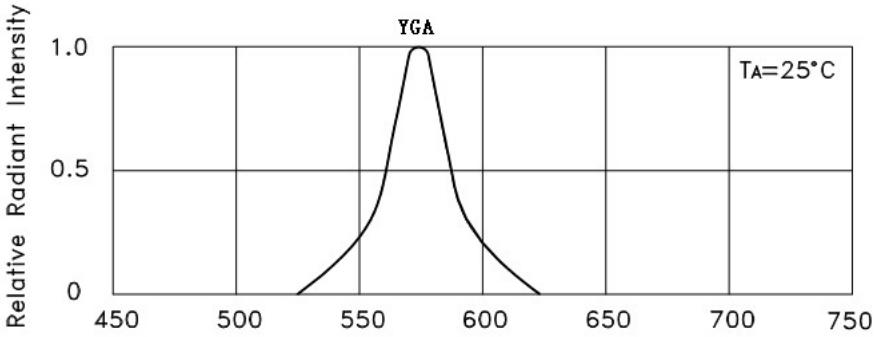
Note: Accuracy may depend on the sorting parameters

Absolute Maximum Ratings at T_A=25°C

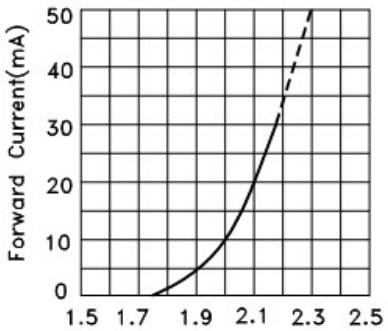
Parameter	Super Bright Orange	Units
Power dissipation	80	mW
DC Forward Current	30	mA
Peak Forward Current [1]	100	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

Note:

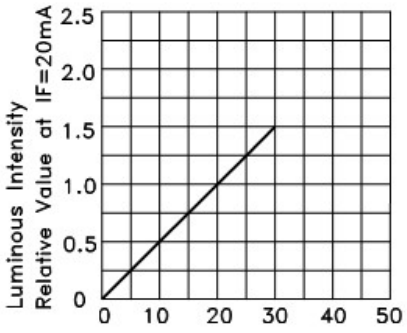
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



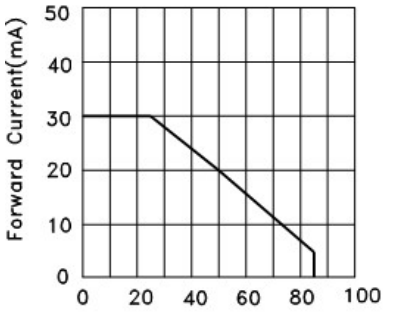
RELATIVE INTENSITY Vs. WAVELENGTH



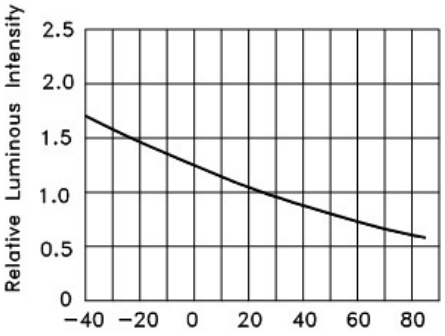
FORWARD CURRENT Vs.
FORWARD VOLTAGE



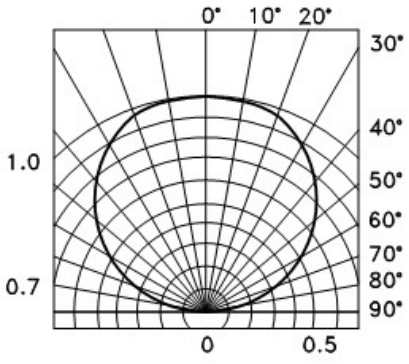
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE



LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

RELIABILITY

Test Items and Results

NO	Test item	Standard	Test Conditions	Note	Quanti ty	Number of Damaged
1	Temperature Cycle	JEITA ED-4701	-40℃～25℃～100℃～ 25℃ 30 min 5 min 30 min 5 min	100 cycle	50	0/50
2	Thermal Shock	MIL-STD-202G	-40℃～100℃ 15 min 15 min	500 cycle	50	0/50
3	High Temperature Storage	JEITA ED-4701 200 201	T_a=100℃	1000hrs	50	0/50
4	Low Temperature Storage	JEITA ED-4701 200 201	T_a=-40℃	1000hrs	50	0/50
5	Life Test		T_a=25±5℃ I_F=20mA	1000hrs	50	0/50
6	High Humidity Heat Cycle		T_a=60℃ RH=85% I_F=20mA	1000hrs	50	0/50
7	Solderability (reflow soldering ）	JEITA ED-4701 300 303	T_{sol}=235℃±5℃,5 sec Use flux	Weld once, 5 sec	10	0/10
8	Solder resistance (reflow soldering)	JEITA ED-4701 300 301	T_{sol}=260℃,10 sec preprocessing ：35℃ 95%RH 96hour	Weld twice, 10 sec each time	10	0/10
Note	If the above test items are different from the customer's test requirements or have special customer requirements, they can be trial-produced according to the actual situation and in accordance with the customer's requirements. If the customer does not require them, they can be trial-produced according to our company's test standards. Different products use different currents for testing.					

5. Cautions

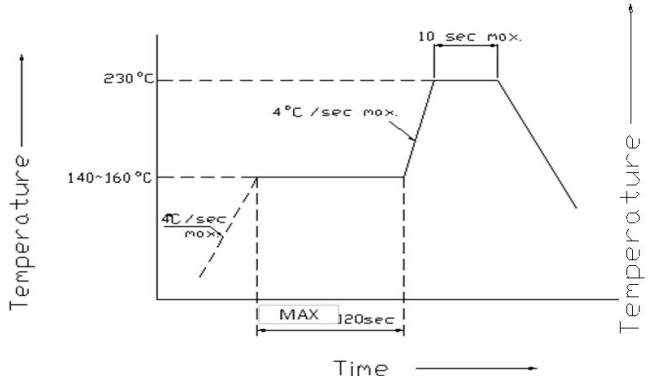
(1) Soldering Conditions

Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and Second soldering process.

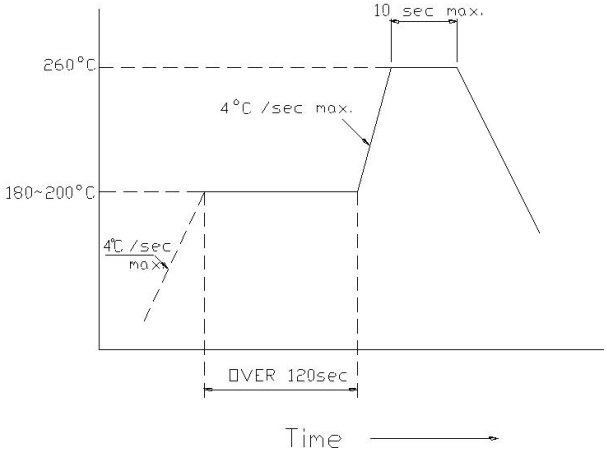
(Recommended soldering conditions)

回流焊接 Reflow Soldering			手工焊接	
	有铅 Lead Solder	无铅 Lead-free Solder	温度 Temperature	350° C Max.
预热温度 Pre-heat	140 ~ 160° C	180 ~ 200° C	焊接时间 Soldering time	3 sec. Max. (one time only)
预热时间 Pre-heat time	120 sec. Max.	120 sec. Max.		
峰值温度 Peak temperature	230° C Max.	260° C Max.		
焊接时间 Soldering time	10 sec. Max.	10 sec. Max.		
条件Condition	参考下图	参考下图		

（Lead Solder）

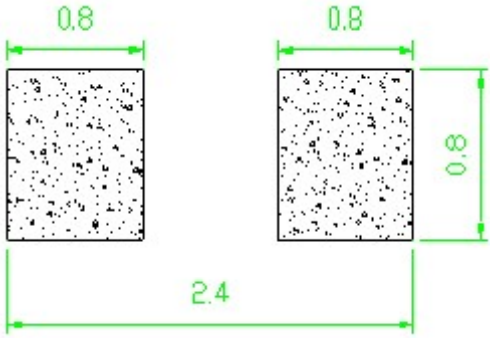


(Lead-Free Solder)



Recommended Soldering Pattern

(Units : mm)



(2) Static Electricity

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

All devices, equipment and machinery must be properly grounded.

Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs do not light at the low current. Criteria : (VF > 2.0V at IF=0.5mA)

(3) Moisture Proof Package

It is recommended that moisture proof package be used .

(4)

Cautions:

4.1.

Please check if there is air leak before opening the package, if so, please return the goods back to take drying process for later using.

4.2

Products can be used within 15days after packaging, after that, they must be:

4.2.1

Soldered within 24 hrs

4.2.2

Used in the condition: 30℃ within and 60%RH below

4.2.

Stored in 30%RH for moisture below.

4.3

Products cannot be used for and over 15days after being packaged unless opening the package and take drying our process in 85℃/6H.

4.4.

Products not be used for or over 60days after being packaged please return back to take drying out and packaging process for forward using.

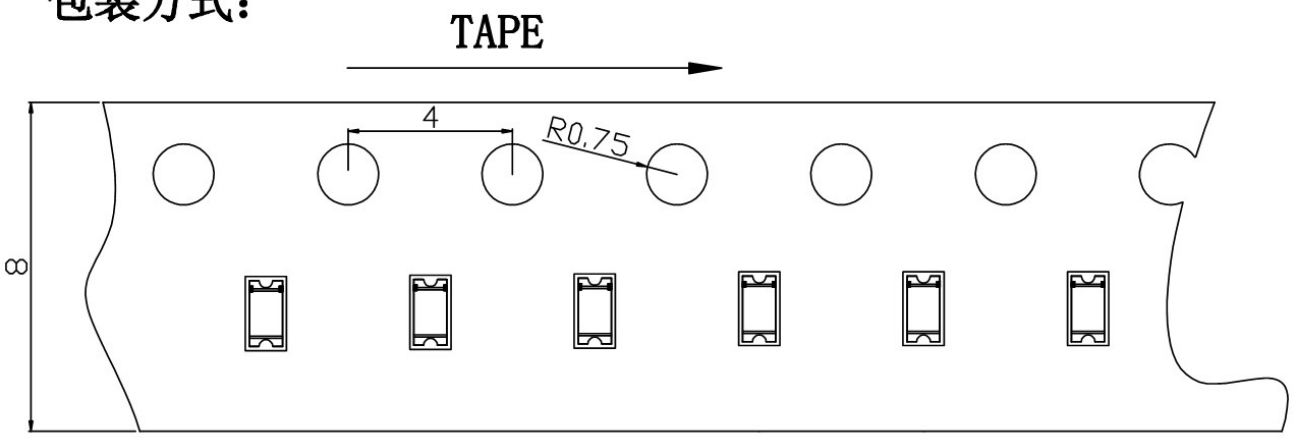
4.5.

Products not be used after opening the package need to be dried out for 85℃/6H

PACKAGING

The LEDs are packed in cardboard boxes after taping.

包装方式：



Package: 4000 pcs/reel

Reel Dimensions

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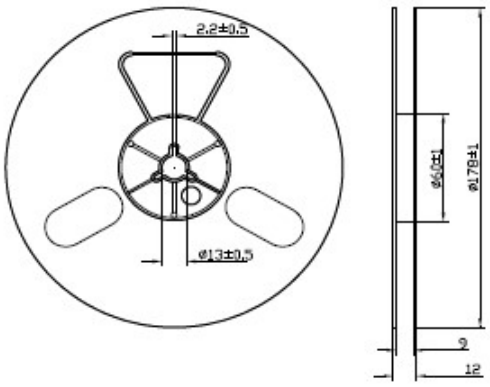
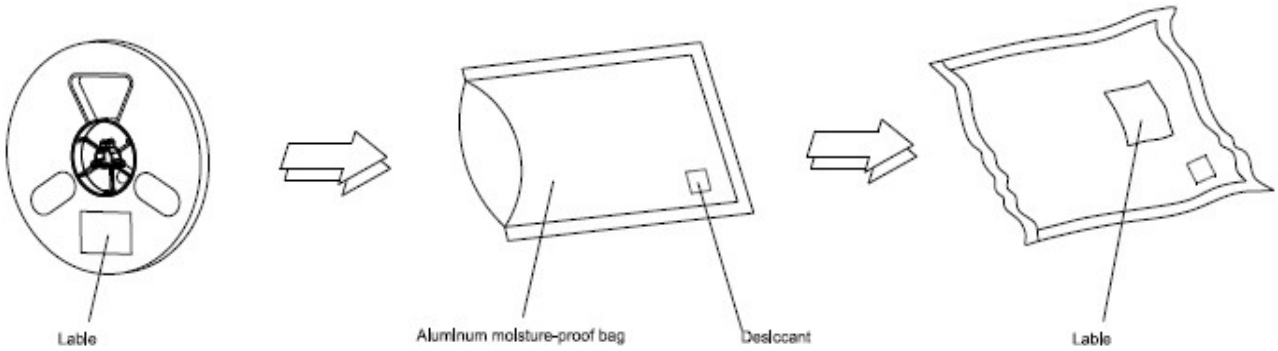


Moisture Resistant Packaging



Note:The tolerances unless mentioned is ±0.1mm,Unit:mm

Test condition： @5mA		
BIN Code	**V_{Fmin} (v)**	**V_{Fmax} (v)**
1	1.7	1.8
2	1.8	1.9
3	1.9	2.0
4	2.0	2.1
5	2.1	2.2
Test condition： @5mA		
BIN Code	**λ_{Dmin} (nm)**	**λ_{Dmax} (nm)**
1	568	570
2	570	572
3	572	574
Test condition： @5mA		
BIN Code	**I_{Vmin} (mcd)**	**I_{Vmax} (mcd)**
B2	1. 2	2.2
C1	2.2	3.6
C2	3.6	5.7